ECMS1V1306 Common mode choke, surface mount



Product features

- High frequency filter
- Square type closed magnetic core
- Current rating up to 10 A
- 13 mm x 11.3 mm surface mount package in a 6.4 mm height
- Moisture sensitivity level (MSL): 1

Applications

- Battery backup
- Renewable energy products
- High tech consumer products
- Appliances
- LED lighting
- Smart meters
- Industrial IoT equipment
- Motion controls
- Power supplies
- Medical equipment

Environmental compliance and general specifications

- Storage temperature (component): -40 °C to +125 °C
- Operating temperature range: -40 °C to +125 °C (ambient plus self-temperature rise)
- Solder reflow temperature: J-STD-020 (latest revision) compliant





Product specifications

Part number⁵	Impedance¹ (Ω) mimimum	Impedance¹ (Ω) typical	DCR² (mΩ) @ +25 °C maximum	Rated current ³ (A) maximum	Rated voltage (Vdc) maximum	Insulation resistance ⁴ @ (MΩ) minimum
ECMS1V1306-231-R	80	230	2.0	10	80	10
ECMS1V1306-701-R	500	700	6.0	8.0	80	10
ECMS1V1306-801-R	600	800	8.0	8.0	80	10
ECMS1V1306-102-R	750	1000	14	6.0	80	10

1. Impedance test parameters: 100 MHz, 0.1 Vrms, parallel connection (1,2 - 4,3), +25 °C

2. DCR test parameters: parallel connection (1,2 - 4,3), 4-wire method measured at +25°C

3. Rated current: DC current for an approximate temperature rise of 40 °C without core loss. It is recommended that the temperature of the part not exceed +125 $^{\circ}\text{C}$ under worst case operating conditions verified in the end application.

4. Insulation resistance: Coil to coil

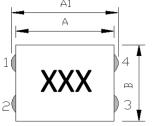
5. Part Number Definition: ECMS1Vxxxx-yyy-R ECMS1V = Product code

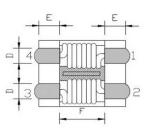
xxxx= Size indicator

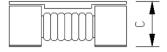
yyy= Typical impedance value in ohms. R= decimal point, if no R is present then last digit indicates the number of zeros

-R suffix = RoHS compliant

Mechanical parameters, schematic, pad layout (mm)





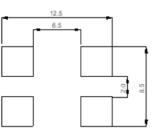




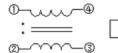
Dimension	Value
A	12.0 ±0.5
A1	12.5 ±0.5
В	10.8 ±0.5
С	6.4 maximum
D	2.7 typical
E	2.5 typical
F	7.0 typical
D E	2.7 typical 2.5 typical

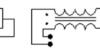
Part marking: xxx= Typical impedance value in ohms All soldering surfaces to be coplanar within 0.1 millimeters Tolerances are ± 0.5 millimeters unless stated otherwise Traces or vias underneath the inductor is not recommended

Recommended PCB Layout



Schematic





No polority

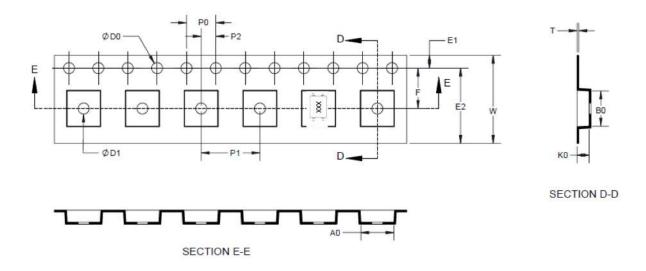
Differential Mode

Conmon Mode

A1

Packaging information (mm)

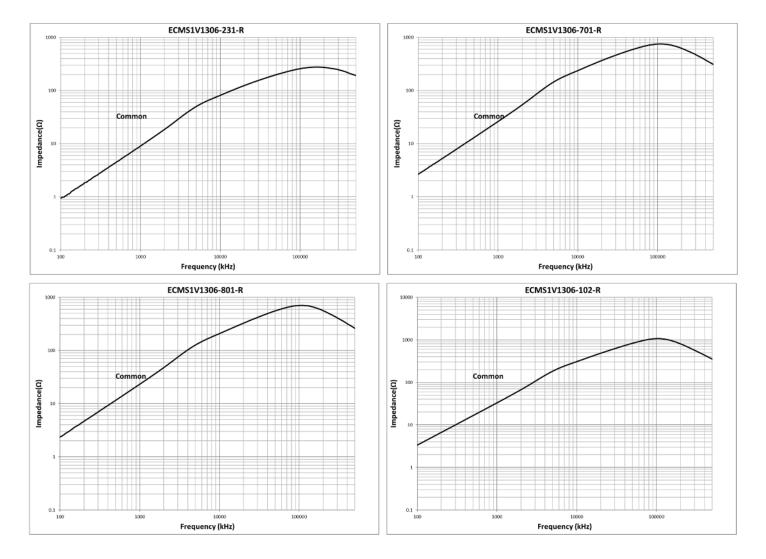
Supplied in tape and reel packaging, 13" diameter reel (EIA-481 compliant) 500 parts per reel



Dimension	Value	Value		
W	24.0 ±0.3			
F	11.5 ±0.1			
E1	1.75 ±0.1			
E2	na			
PO	4.0 ±0.1			
P1	16 ±0.1			
P2	2.0 ±0.1			
DO	1.5 +0.1/-0			
D1	1.5 +0.1/-0			
AO	12.5 ±0.1			
BO	11.5 ±0.1			
КО	6.6 ±0.1			
T	0.4 ±0.05			

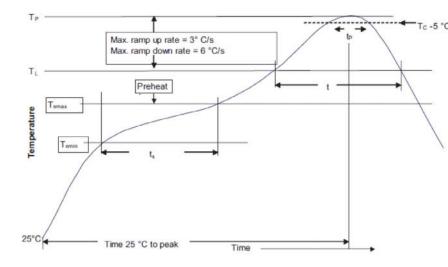
Technical Data **ELX1114** Effective December 2021

Impedance vs frequency



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Solder reflow profile



T_c -5 °C Table 1 - Standard SnPb solder (T_c)

Package Thickness	Volume mm3 <350	Volume mm3 ≥350
<2.5 mm)	235 °C	220 °C
≥2.5 mm	220 °C	220 °C

Table 2 - Lead (Pb) free solder (T_c)

Package thickness	Volume mm ³ <350	Volume mm ³ 350 - 2000	Volume mm ³ >2000
<1.6 mm	260 °C	260 °C	260 °C
1.6 – 2.5 mm	260 °C	250 °C	245 °C
>2.5 mm	250 °C	245 °C	245 °C

Reference J-STD-020

Profile feature	Standard SnPb solder	Lead (Pb) free solder
Preheat and soak • Temperature min. (T _{smin})	100 °C	150 °C
• Temperature max. (T _{smax})	150 °C	200 °C
• Time (T _{smin} to T _{smax}) (t _s)	60-120 seconds	60-120 seconds
Ramp up rate TL to Tp	3 °C/ second max.	3 °C/ second max.
Liquidous temperature (TL) Time (tL) maintained above ${\rm T_L}$	183 °C 60-150 seconds	217 °C 60-150 seconds
Peak package body temperature (Tp)*	Table 1	Table 2
Time $(t_p)^*$ within 5 °C of the specified classification temperature (T_c)	20 seconds*	30 seconds*
Ramp-down rate (T _p to TL)	6 °C/ second max.	6 °C/ second max.
Time 25 °C to peak temperature	6 minutes max.	8 minutes max.

* Tolerance for peak profile temperature (T_n) is defined as a supplier minimum and a user maximum.

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